

LTC4150

### Coulomb Counter/ Battery Gas Gauge

### FEATURES

- Indicates Charge Quantity and Polarity
- ±50mV Sense Voltage Range
- Precision Timer Capacitor or Crystal Not Required
- 2.7V to 8.5V Operation
- High Side Sense
- 32.55Hz/V Charge Count Frequency
- 1.5µA Shutdown Current
- 10-Pin MSOP Package

#### **APPLICATIONS**

- Battery Chargers
- Palmtop Computers and PDAs
- Cellular Telephones and Wireless Modems

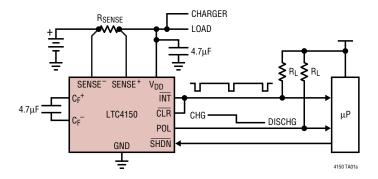
# TYPICAL APPLICATION



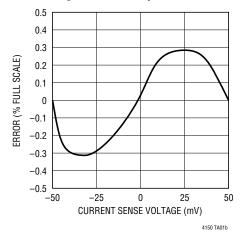
The LTC<sup>®</sup>4150 measures battery depletion and charging in handheld PC and portable product applications. The device monitors current through an external sense resistor between the battery's positive terminal and the battery's load or charger. A voltage-to-frequency converter transforms the current sense voltage into a series of output pulses at the interrupt pin. These pulses correspond to a fixed quantity of charge flowing into or out of the battery. The part also indicates charge polarity as the battery is depleted or charged.

The LTC4150 is intended for 1-cell or 2-cell Li-lon and 3-cell to 6-cell NiCd or NiMH applications.

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#### Integral Nonlinearity, % of Full Scale

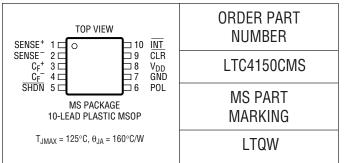


# **ABSOLUTE MAXIMUM RATINGS**

(Note 1)

Supply Voltage (V <sub>DD</sub> )0.3V to 9V
Input Voltage Range
Digital Inputs (CLR, SHDN) – 0.3V to (V <sub>DD</sub> + 0.3)
SENSE <sup>-</sup> , SENSE <sup>+</sup> , $C_{F}^{-}$ , $C_{F}^{+}$ 0.3V to (V <sub>DD</sub> + 0.3)
Output Voltage Range
Digital Outputs (INT, POL)0.3V to 9V
Operating Temperature Range 0°C to 70°C
Storage Temperature Range –65°C to 150°C
Lead Temperature (Soldering, 10 sec)

## PACKAGE/ORDER INFORMATION



Consult LTC Marketing for parts specified with wider operating temperature ranges.

# **ELECTRICAL CHARACTERISTICS** The $\bullet$ denotes the specifications which apply over the full operating temperature range, otherwise specifications are at T<sub>A</sub> = 25°C. V<sub>DD</sub> = 2.7V and 8.5V unless otherwise noted.

SYMBOL	PARAMETER	CONDITIONS		MIN	ТҮР	MAX	UNITS
V <sub>IL</sub>	Digital Input Low Voltage, CLR, SHDN		•			0.7	V
V <sub>IH</sub>	Digital Input High Voltage, CLR, SHDN		•	1.9			V
V <sub>OL</sub>	Digital Output Low Voltage, INT, POL	I <sub>OL</sub> = 1.6mA, V <sub>DD</sub> = 2.7V				0.5	V
ILEAK	Digital Output Leakage Current, INT, POL	V <sub>INT</sub> = V <sub>POL</sub> = 8.5V	•		0.01	1	μA
V <sub>OS</sub>	Differential Offset Voltage, (Note 4)	V <sub>DD</sub> = 4.0V				±100	μV
			•			±150	μV
		V <sub>DD</sub> = 8.0V				±100	μV
			•			±150	μV
		V <sub>DD</sub> = 2.7V to 8.5V				±150	μV
			•			<u>+200</u>	μV
V <sub>SENSE(CM)</sub>	Sense Voltage Common Mode Input Range		•	V <sub>DD</sub> - 0.06		$V_{DD} + 0.06$	V
V <sub>SENSE</sub>	Sense Voltage Differential Input Range	SENSE <sup>+</sup> – SENSE <sup>-</sup>	•	-0.05		0.05	V
R <sub>IDR</sub>	Average Differential Input Resistance, Across SENSE <sup>+</sup> and SENSE <sup>-</sup>	V <sub>DD</sub> = 4.1V, (Note 3)		155	270	390	kΩ
V <sub>UVLO</sub>	Undervoltage Lockout Threshold	V <sub>DD</sub> Rising			2.5	2.7	V
Power Supply	y Current						
I <sub>DD</sub>	Supply Current, Operating	V <sub>DD</sub> = 8.5V			115	140	μA
		V <sub>DD</sub> = 2.7V	•		80	100	μA
I <sub>DD(SD)</sub>	Supply Current, Shutdown	V <sub>DD</sub> = 8.5V	•			10	μA
		V <sub>DD</sub> = 2.7V	•			1.5	μA
AC Character	istics						
G <sub>VF</sub>	Voltage to Frequency Gain	$V_{\text{SENSE}} = 50 \text{mV} \text{ to} - 50 \text{mV},$		32.0	32.55	33.1	Hz/V
		$2.7V \le V_{DD} \le 8.5V$	•	31.8		33.3	Hz/V
$\Delta G_{VF}(V_{DD})$	Gain Variation with Supply	$2.7V \le V_{DD} \le 8.5V$		0		0.5	%/V
$\Delta G_{VF}(TEMP)$	Gain Variation with Temperature	(Note 2)	•	-0.03		0.03	%/ °C
INL	Integral Nonlinearity			-0.4		0.4	%
			•	-0.5		0.5	Full Scale
t <sub>CLR</sub>	CLR Pulse Width to Reset INT, INT and CLR Not Connected	Figure 2, V <sub>DD</sub> = 4.1V		20			μs
t <sub>INT</sub>	INT Low Time, INT Connected to CLR	Figure 3, $C_L = 15pF$		1			μs

**Note 1:** Absolute Maximum Ratings are those values beyond which the life of a device may be impaired.

Note 3: Measured at least 20ms after power on.

Note 4: Tested in feedback loop to SENSE<sup>+</sup> and SENSE<sup>-</sup>.

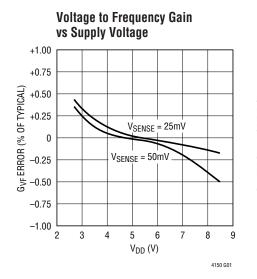
Note 2: Guaranteed by design and not tested in production.

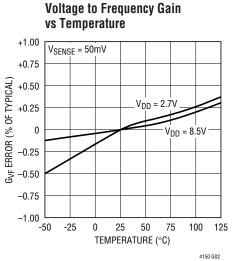


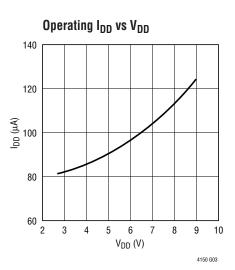
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# **TYPICAL PERFORMANCE CHARACTERISTICS** (Specifications are at $T_A = 25^{\circ}C$ , unless

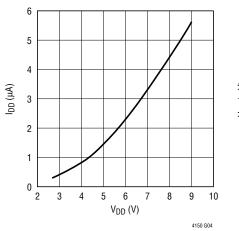
otherwise noted.)



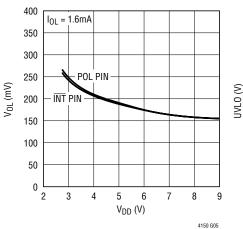




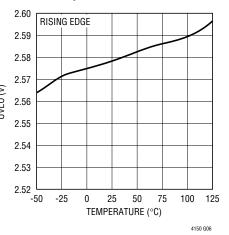
Shutdown I<sub>DD</sub> vs V<sub>DD</sub>



Digital Output Low Voltage vs V<sub>DD</sub>



# Undervoltage Lockout Threshold vs Temperature





## PIN FUNCTIONS

**SENSE<sup>+</sup>** (Pin1): Positive Sense Input. This is the noninverting current sense input. Connect SENSE<sup>+</sup> to the load and charger side of the sense resistor. Full-scale current sense input is 50mV. SENSE<sup>+</sup> must be within 60mV of V<sub>DD</sub> for proper operation.

**SENSE<sup>-</sup> (Pin 2):** Negative Sense Input. This is the inverting current sense input. Connect SENSE<sup>-</sup> to the positive battery terminal side of the sense resistor. Full-scale current sense input is 50mV. SENSE<sup>-</sup> must be within 60mV of  $V_{DD}$  for proper operation.

 $C_F^+$  (Pin 3): Filter Capacitor Positive Input. A capacitor connected between  $C_F^+$  and  $C_F^-$  filters and averages noise and fast battery current variations. A 4.7 $\mu$ F value is recommended. If filtering is not desired, leave  $C_F^+$  and  $C_F^-$  unconnected.

 $C_F^-$  (Pin 4): Filter Capacitor Negative Input. A capacitor connected between  $C_F^+$  and  $C_F^-$  filters and averages noise and fast battery current variations. A 4.7 $\mu$ F value is recommended. If filtering is not desired, leave  $C_F^+$  and  $C_F^-$  unconnected.

**SHDN** (Pin 5): Shutdown Digital Input. When asserted low, SHDN forces the LTC4150 into its low current consumption power-down mode and resets the part. In applications with logic supply  $V_{CC} > V_{DD}$ , a resistive divider must be used between SHDN and the logic which drives it. See the Applications Information section.

**POL (Pin 6):** Battery Current Polarity Open-Drain Output. POL indicates the most recent battery current polarity when INT is high. A low state indicates the current is flowing out of the battery while high impedance means the current is going into the battery. POL latches its state when INT is asserted low. POL is an open-drain output and can be pulled up to any logic supply up to 9V. In shutdown, POL is high impedance.

**GND (Pin 7):** Ground. Connect directly to the negative battery terminal.

 $V_{DD}$  (Pin 8): Positive Power Supply. Connect to the load and charger side of the sense resistor. SENSE<sup>+</sup> also connects to V<sub>DD</sub>. V<sub>DD</sub> operating range is 2.7V to 8.5V. Bypass V<sub>DD</sub> with 4.7µF capacitor.

**CLR** (Pin 9): Clear Interrupt Digital Input. When asserted low for more than 20 $\mu$ s, CLR resets INT high. Charge counting is *unaffected*. INT may be directly connected to CLR. In this case the LTC4150 will capture each assertion of INT and wait at least 1 $\mu$ s before resetting it. This ensures that INT pulses low for at least 1 $\mu$ s but gives automatic INT reset. In applications with a logic supply V<sub>CC</sub> > V<sub>DD</sub>, a resistive divider must be used between INT and CLR. See the Applications Information section.

**INT** (Pin 10): Charge Count Interrupt Open-Drain Output. INT latches low every  $1/(V_{SENSE} \bullet G_{VF})$  seconds and is reset by a low pulse at CLR. INT is an open-drain output and can be pulled up to any logic supply of up to 9V. In shutdown INT is high impedance.



### **BLOCK DIAGRAM**

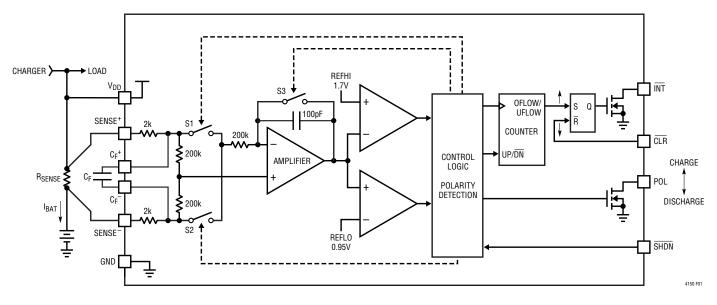


Figure 1. Block Diagram

### TIMING DIAGRAMS

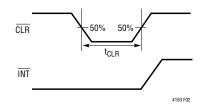


Figure 2. CLR Pulse Width to Reset INT, CLR and INT Not Connected

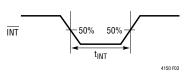


Figure 3.  $\overline{\text{INT}}$  Minimum Pulse Width,  $\overline{\text{CLR}}$  and  $\overline{\text{INT}}$  Connected



# OPERATION

Charge is the time integral of current. The LTC4150 measures battery current by monitoring the voltage developed across a sense resistor and then integrates this information in several stages to infer charge. The Block Diagram shows the stages described below. As each unit of charge passes into or out of the battery, the LTC4150 INT pin interrupts an external microcontroller and the POL pin reports the polarity of the charge unit. The external microcontroller then resets INT with the CLR input in preparation for the next interrupt issued by the LTC4150. The value of each charge unit is determined by the sense resistor value and the sense voltage to interupt frequency gain  $G_{VF}$  of the LTC4150.

#### Power-On and Start-Up Initialization

When power is first applied to the LTC4150, all internal circuitry is reset. After an initialization interval, the LTC4150 begins counting charge. This interval depends on  $V_{DD}$  and the voltage across the sense resistor but will be at least 5ms. It may take an additional 80ms for the LTC4150 to accurately track the sense voltage. An internal undervoltage lockout circuit monitors  $V_{DD}$  and resets all circuitry when  $V_{DD}$  falls below 2.5V.

Asserting SHDN low also resets the LTC4150's internal circuitry and reduces the supply current to  $1.5\mu$ A. In this condition, POL and INT outputs are high impedance. The LTC4150 resumes counting after another initialization interval. Shutdown minimizes battery drain when both the charger and load are off.

#### **CHARGE COUNTING**

First, the current measurement is filtered by capacitor  $C_F$  connected across pins  $C_F^+$  and  $C_F^-$ . This averages fast changes in current arising from ripple, noise and spikes in the load or charging current.

Second, the filter's output is applied to an integrator with the amplifier and 100pF capacitor at its core. When the integrator output ramps to REFHI or REFLO levels, switches S1 and S2 reverse the ramp direction. By observing the condition of S1 and S2 and the ramp direction, polarity is determined. The integrating interval is trimmed to 600µs at 50mV full-scale sense voltage.

Third, a counter is incremented or decremented every time the integrator changes ramp direction. The counter effectively increases integration time by a factor of 1024, greatly reducing microcontroller overhead required to service interrupts from the LTC4150.

At each counter under or overflow, the INT output latches low, flagging a microcontroller. Simultaneously, the POL output is latched to indicate the polarity of the observed charge. With this information, the microcontroller can total the charge over long periods of time, developing an accurate estimate of the battery's condition. Once the interrupt is recognized, the microcontroller resets INT with a low going pulse on CLR and awaits the next interrupt. Alternatively, INT can drive CLR.



#### SENSE VOLTAGE INPUT AND FILTERS

Since the overall integration time is set by internally trimming the LTC4150, no external timing capacitor or trimming is necessary. The only external component that affects the transfer function of interrupts per coulomb of charge is the sense resistor,  $R_{SENSE}$ . The common mode range for the SENSE<sup>+</sup> and SENSE<sup>-</sup> pins is  $V_{DD}$ ±60mV, with a maximum differential voltage range of ±50mV. SENSE<sup>+</sup> is normally tied to  $V_{DD}$ , so there is no common mode issue when SENSE<sup>-</sup> operates within the 50mV differential limit relative to SENSE<sup>+</sup>.

Choose  $R_{SENSE}$  to provide 50mV drop at maximum charge or discharge current, whichever is greater. Calculate  $R_{SENSE}$  from:

$$R_{SENSE} = \frac{50 \text{mV}}{I_{MAX}} \tag{1}$$

The sense input range is small ( $\pm$ 50mV) to minimize the loss across R<sub>SENSE</sub>. To preserve accuracy, use Kelvin connections at R<sub>SENSE</sub>.

The external filter capacitor  $C_F$  operates against a total onchip resistance of 4k to form a lowpass filter that averages battery current and improves accuracy in the presence of noise, spikes and ripple. 4.7µF is recommended for general applications but can be extended to higher values as long as the capacitor's leakage is low. A 10nA leakage is roughly equivalent to the input offset error of the integrator. Ceramic capacitors are suitable for this use.

Switching regulators are a particular concern because they generate high levels of current ripple which may flow through the battery. The  $V_{DD}$  and SENSE<sup>+</sup> connection to the charger and load should be bypassed by at least 4.7 $\mu$ F at the LTC4150 if a switching regulator is present.

The LTC4150 maintains high accuracy even when Burst Mode<sup>®</sup> switching regulators are used. Burst pulse "on" levels must be within the specified differential input voltage range of 50mV as measured at  $C_F^+$  and  $C_F^-$ . To retain accurate charge information, the LTC4150 must remain enabled during Burst Mode operation. If the LTC4150 shuts down or V<sub>DD</sub> drops below 2.5V, the part resets and charge information is lost.

#### **Coulomb Counting**

The LTC4150's transfer function is quantified as a voltage to frequency gain  $G_{VF}$ , where output frequency is the number of interrupts per second and input voltage is the differential drive  $V_{SENSE}$  across SENSE<sup>+</sup> and SENSE<sup>-</sup>. The number of interrupts per second will be:

$$f = G_{VF} \bullet |V_{SENSE}|$$
(2)

where

$$V_{SENSE} = I_{BATTERY} \bullet R_{SENSE}$$
(3)

Therefore,

$$f = G_{VF} \bullet |I_{BATTERY} \bullet R_{SENSE}|$$
(4)

Since  $I \bullet t = Q$ , coulombs of battery charge per  $\overline{INT}$  pulse can be derived from Equation 4:

One 
$$\overline{INT} = \frac{1}{G_{VF} \bullet R_{SENSE}}$$
 Coulombs (5)

Battery capacity is most often expressed in ampere-hours.

Combining Equations 5 and 6:

One 
$$\overline{INT} = \frac{1}{3600 \bullet G_{VF} \bullet R_{SENSE}}$$
 [Ah] (7)

or

$$1Ah = 3600 \bullet G_{VF} \bullet R_{SENSE} \text{ Interrupts}$$
(8)

The charge measurement may be further scaled within the microcontroller. However, the number of interrupts, coulombs or Ah all represent battery charge.

The LTC4150's transfer function is set only by the value of the sense resistor and the gain  $G_{VF}$ . Once  $R_{SENSE}$  is selected using Equation 1, the charge per interrupt can be determined from Equation 5 or 7.

Note that  $R_{SENSE}$  is not chosen to set the relationship between ampere-hours of battery charge and number of interrupts issued by the LTC4150. Rather,  $R_{SENSE}$  is chosen to keep the maximum sense voltage equal to or less than the LTC4150's 50mV full-scale sense input.

Burst Mode is registered trademark of Linear Technology Corporation.



#### $\overline{\text{INT}}, \text{ POL} \text{ and } \overline{\text{CLR}}$

INT asserts low each time the LTC4150 measures a unit of charge. At the same time, POL is latched to indicate the polarity of the charge unit. The integrator and counter continue running, so the microcontroller must service and clear the interrupt before another unit of charge accumulates. Otherwise, one measurement will be lost. The time available between interrupts is the reciprocal of Equation 2:

$$\text{Time per } \overline{\text{INT}} \text{ Assertion} = \frac{1}{G_{\text{VF}} \bullet |V_{\text{SENSE}}|}$$
(9)

At 50mV full scale, the minimum time available is 596ms. To be conservative and accommodate for small, unexpected excursions above the 50mV sense voltage limit, the microcontroller should <u>process</u> the interrupt and polarity information and clear INT within 500ms.

Toggling CLR low for at least 20µs resets INT high and unlatches POL. Since the LTC4150's integrator and counter operate independently of the INT and POL latches, no charge information is lost during the latched period or while CLR is low. Charge/discharge information continues to accumulate during those intervals and accuracy is unaffected.

Once cleared, INT idles in a high state and POL indicates real-time polarity of the battery current. POL high indicates charge flowing into the battery and low indicates charge flowing out. Indication of a polarity change requires at least:

$$t_{POL} = \frac{2}{G_{VF} \bullet 1024 \bullet |V_{SENSE}|}$$
(10)

where  $V_{\mbox{SENSE}}$  is the smallest sense voltage magnitude before and after the polarity change.

Open-drain outputs POL and  $\overline{INT}$  can sink  $I_{OL}$  = 1.6mA at  $V_{OL}$  = 0.5V. The minimum pull-up resistance for these pins should be:

$$R_L > (V_{CC} - 0.5) / 1.6 mA$$
 (11)

where  $V_{CC}$  is the logic supply voltage. Because speed isn't an issue, pull-up resistors of 10k or higher are adequate.

#### Interfacing to $\overline{\text{INT}}$ , POL, $\overline{\text{CLR}}$ and $\overline{\text{SHDN}}$

The LTC4150 operates directly from the battery, while in most cases the microcontroller supply comes from some separate, regulated source. This poses no problem for INT and POL because they are open-drain outputs and can be pulled up to any voltage 9V or less, regardless of the voltage applied to the LTC4150's  $V_{DD}$ .

 $\overline{\text{CLR}}$  and  $\overline{\text{SHDN}}$  inputs require special attention. To drive them, the microcontroller or external logic must generate a minimum logic high level of 1.9V. The maximum input level for these pins is V<sub>DD</sub> + 0.3V. If the microcontroller's supply is more than this, resistive dividers must be used on  $\overline{\text{CLR}}$  and  $\overline{\text{SHDN}}$ . The schematic in Figure 6 shows an application with INT driving  $\overline{\text{CLR}}$  and microcontroller V<sub>CC</sub> > V<sub>DD</sub>. The resistive dividers on  $\overline{\text{CLR}}$  and  $\overline{\text{SHDN}}$  keep the voltages at these pins within the LTC4150's V<sub>DD</sub> range. Choose R2 and R1 so that:

$$(R1 + R2) \ge 50R_L \tag{12}$$

$$1.9V \le \frac{R1}{R1+R2} V_{CC} \le V_{DD} \text{ (Minimum)}$$
(13)

Equation 13 also applies to the selection of R3 and R4. The minimum  $V_{DD}$  is the lowest supply to the LTC4150 when the battery powering it is at its lowest discharged voltage.

When the battery is removed in any application, the  $\overline{\text{CLR}}$  and  $\overline{\text{SHDN}}$  inputs are unpredictable. INT and POL outputs may be erratic and should be ignored until after the battery is replaced.

If desired, the simple logic of Figure 4 may be used to derive separate charge and discharge pulse trains from  $\overline{\text{INT}}$  and POL.

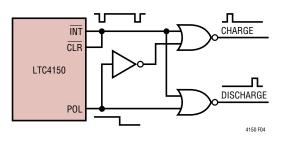


Figure 4. Unravelling Polarity— Separate Charge and Discharge Outputs



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#### AUTOMATIC CHARGE COUNT INTERRUPT AND CLEAR

In applications where a  $\overline{\text{CLR}}$  pulse is unavailable, it's easy to make the LTC4150 run autonomously, as shown in Figures 5 and 6. If the microcontroller  $V_{CC}$  is less than or equal to the battery  $V_{DD}$ ,  $\overline{\text{INT}}$  may be directly connected to  $\overline{\text{CLR}}$ , as in Figure 5. The only requirement is that the microcontroller should be able to provide a high logic level of 1.9V to SHDN. If the microcontroller  $V_{CC}$  is greater than

the battery  $V_{DD}$ , use Figure 6. The resistor dividers on  $\overline{CLR}$  and  $\overline{SHDN}$  keep the voltages at these pins within the LTC4150's  $V_{DD}$  range. Choose an  $R_L$  value using Equation 11 and R1-R4 values using Equation 13. In either application, the LTC4150 will capture the first assertion of INT and wait at least 1µs before resetting it. This insures that INT pulses low for at least 1µs but gives automatic INT reset.

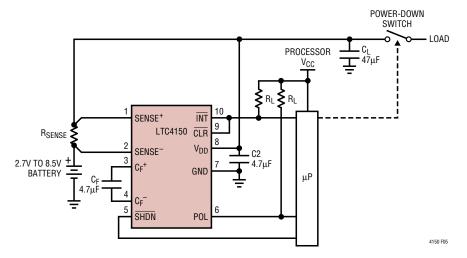


Figure 5. Application with  $\overline{\text{INT}}$  Direct Drive of  $\overline{\text{CLR}}$  and Separate Microprocessor Supply  $V_{\text{CC}} \leq V_{\text{DD}}$ 

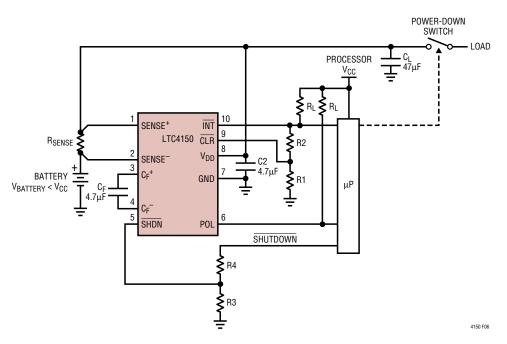


Figure 6. Application with INT Driving  $\overline{\text{CLR}}$  and Separate Microprocessor Supply  $V_{CC} > V_{DD}$ 



#### PC BOARD LAYOUT SUGGESTIONS

Keep all traces as short as possible to minimize noise and inaccuracy. The supply bypass capacitor C2 should be placed close to the LTC4150. The  $4.7\mu$ F filter capacitor C<sub>F</sub> should be placed close the C<sub>F</sub><sup>+</sup> and C<sub>F</sub><sup>-</sup> pins and should be a low leakage, unpolarized type. Use a 4-wire Kelvin sense connection for the sense resistor, locating it close to the LTC4150 with short sense traces to the SENSE<sup>+</sup> and SENSE<sup>-</sup> pins and longer force lines to the battery pack and powered load, see Figure 7.

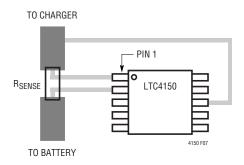


Figure 7. Kelvin Connection on SENSE Resistor

# TYPICAL APPLICATIONS

Figure 8 shows a typical application designed for a single cell lithium-ion battery and 500mA maximum load current. Use Equation 1 to calculate  $R_{SENSE} = 0.05V / 0.5A = 0.1\Omega$ .

With  $R_{SENSE} = 0.1\Omega$ , Equation 7 shows that each interrupt corresponds to 0.085mAh. Equation 14, derived from Equation 2, gives the number of INT assertions for average battery current,  $I_{BATT}$ , over a time, t, in seconds:

$$\overline{INT} \text{ Assertions} = G_{VF} \bullet I_{BATT} \bullet R_{SENSE} \bullet t$$
(14)

Loading the battery so that 51.5mA is drawn from it over 600 seconds results in 100 INT assertions. For an 800mAh battery, this is  $(51.5mA \cdot 1/6h) / 800mAh = 11\%$  of the battery's capacity.

With a microcontroller supply = 5V, Equation 11 gives  $R_L > 2.875k$ . The nearest standard value is 3k.

From Equation 12,  $R_L = 3k$  gives R1 + R2 equal to 150.5k. A single cell lithium-ion battery can discharge as low as 2.7V.

From Equation 13, select R1 = 75k; the nearest standard value for R2 is 76.8k.

Also from Equation 13, we choose R3 = 75k and R4 = 76.8k.

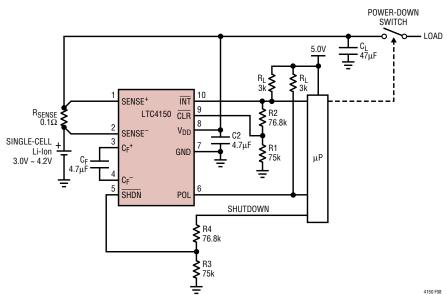
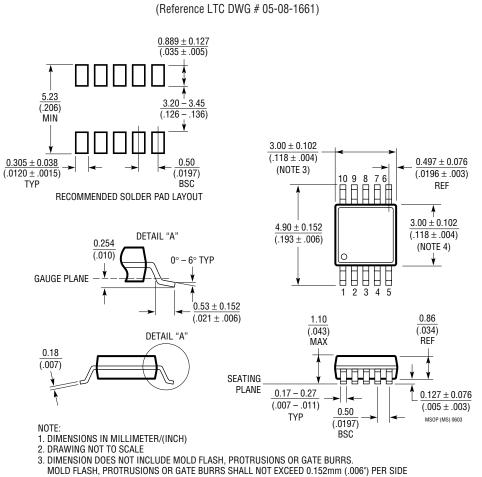


Figure 8. Typical Application, Single Cell Lithium-Ion Battery



### PACKAGE DESCRIPTION



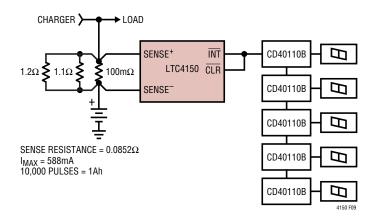
4. DIMENSION DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSIONS.

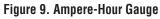
INTERLEAD FLASH OR PROTRUSIONS SHALL NOT EXCEED 0.152mm (.006") PER SIDE 5. LEAD COPLANARITY (BOTTOM OF LEADS AFTER FORMING) SHALL BE 0.102mm (.004") MAX

MS Package 10-Lead Plastic MSOP



# TYPICAL APPLICATIONS





# **RELATED PARTS**

PART NUMBER	DESCRIPTION	COMMENTS	
LTC1732	Lithium-Ion Linear Battery Charger Controller	Simple Charger uses External FET, Features Preset Voltages, C/10 Charger Detection and Programmable Timer, Input Power Good Indication	
LTC1733	Monolithic Lithium-Ion Linear Battery Charger Standalone Charger with Programmable Timer, Up to 1.5A Charge (		
LTC1734	Lithium-Ion Linear Battery Charger in ThinSOT™	er in ThinSOT <sup>™</sup> Simple ThinSOT Charger, No Blocking Diode, No Sense Resistor Needed	
LTC1734L	Lithium-Ion Linear Battery Charger in ThinSOT	Low Current Version of LTC1734	
LTC1998	Lithium-Ion Low Battery Detector	on Low Battery Detector 1% Accurate 2.5µA Quiescent Current, SOT-23	
LTC4006	Small, High Efficiency, Fixed Voltage, Lithium-Ion Battery Charger	Constant-Current/Constant Voltage Switching Regulator with Termination Timer, AC Adapter Current Limit and Thermistor Sensor in a Small 16-Pin Package	
LTC4050	Lithium-Ion Linear Battery Charger Controller	Simple Charger uses External FET, Features Preset Voltages, C/10 Charger Detection and Programmable Timer, Input Power Good Indication, Thermistor Interface	
LTC4052	Monolithic Lithium-Ion Battery Pulse Charger	No Blocking Diode or External Power FET Required, Safety Current Limit	
LTC4053	USB Compatible Monolithic Lithium-Ion Battery Charger	Standalone Charger with Programmable Timer, Up to 1.25A Charge Current	
LTC4054	800mA Standalone Linear Lithium-Ion Battery Charger with Thermal Regulation in ThinSOT	No External MOSFET, Sense Resistor or Blocking Diode Required, Charge Current Monitor for Gas Gauging, C/10 Charge Termination	
LTC4410	USB Power Manager	For Simultaneous Operation of USB Peripheral and Battery Charging from USB Port, Keeps Current Drawn from USB Port Constant, Keeps Battery Fresh, Use with the LTC4053, LTC1733, LTC4054	
LTC4412	PowerPath™ Controller in ThinSOT	More Efficient Diode OR'ing, Automatic Switching Between DC Sources, Simplified Load Sharing, $3V \le V_{IN} \le 28V$	

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